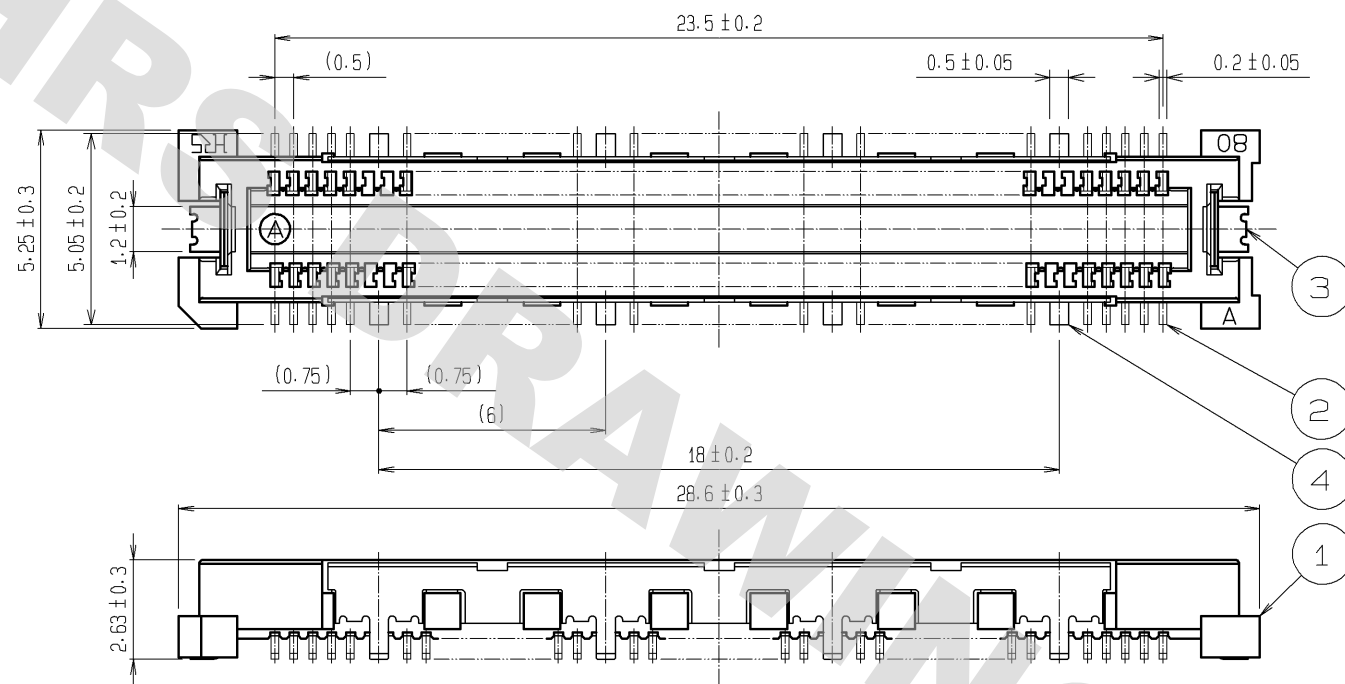
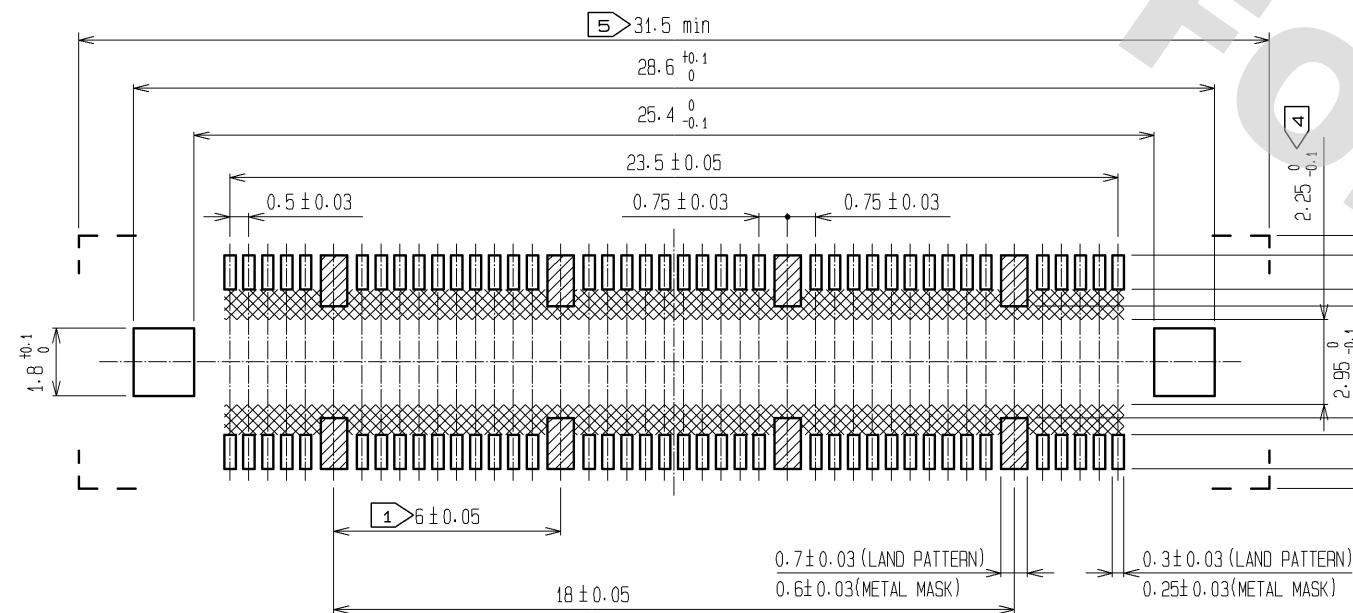


DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

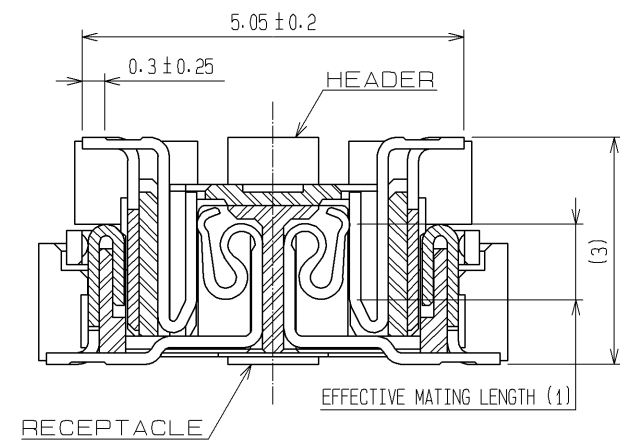


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS:0.15mm)

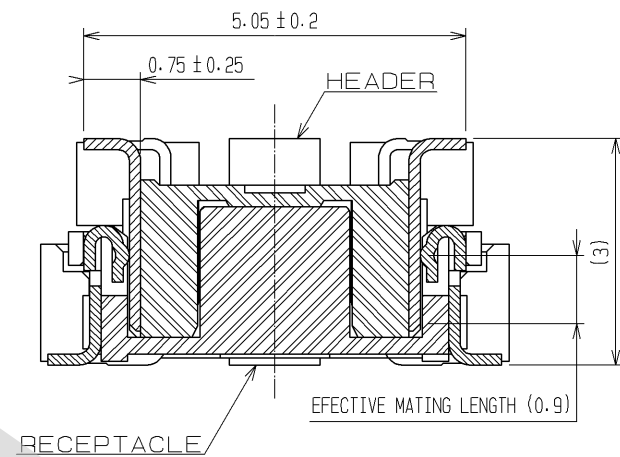


- NOTES
- ① 8 HATCHED PARTS: GROUND CIRCUIT.
 - ② SMT LEAD-COPLANARITY: 0.1 MAX.
 - ③ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ④ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND. OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑤ DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

SIGNAL PORTION CROSS SECTION (10:1)



GROUND PORTION CROSS SECTION (10:1)



3, 4	PHOSPHOR BRONZE	TIN PLATING	2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.
1	LCP	BEIGE UL94V-0			LEAD AREA : GOLD 0.05μm min.
					UNDER PLATING : NICKEL 1μm min.
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS
UNITS mm		SCALE 5 : 1	COUNT △	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	12.03.12	DRAWING NO.	EDC3-152619-25
		CHECKED : HT. YAMAGUCHI	12.03.12	PART NO.	FX11B-80P/8-SV0.5(71)
		DESIGNED : TS. MIYAKI	12.03.12	CODE NO.	CL573-0613-0-71
		DRAWN : TS. MIYAKI	12.03.12		